BeatMark Software to reduce the cost of x-ray mirrors (Stochastic Analysis of Surface Metrology data)

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Anastasia Tyurina (SecondStar), Yury Tyurin (SecondStar), Valeriy Yashchuk (LBNL)

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Second Star Algonumerix: http://www.secondstaralgonumerix.com

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Overview

- 1. Our team and collaborators
- 2. Challenges in X-Ray mirror fabrication for Lynx X-Ray surveyor
- 3. What does the method solve?
- 4. Patterns and stochastic processes
- 5. 1D InTILF analysis method
- 6. BeatMark software
- 7. 2D analysis method
- 8. Planned Polishing Optimization
- 9. Conclusions



Our Team has over 160 years combined experience in developing new mathematical methods into software

Research and Math





Anastasia Tyurina Prof. Yury Tyurin CEO and CTO head of math development

Business Development





Chris Ilsley Michael McComas (Proposals) (Strategy)



Software team

Dr. Sergey Panov (Lead/physics)

Doug Paris (GUI)

Peter Panov (GUI/IT/ Platforms)

IP and licensing



Michelle Freno (licensing) (IP)



Anna Ganelina





Interns



Jonathan Borowsky (WASHU) Daniella Ganelin (MIT) Jacob Panov (NHS)

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Second Star works with amazing collaborators



Polishing and metrology tools manufacturer



Dave Mohring (SBIR) Mike Bechtold (CEO)



Ed Fess (R&D head)



The best Metrology Lab in US





Dr Valeriy Yashchuk



Our collaborators think that if our technology works it will bring a revolution in polishing



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Misha Gubarev.

The project would not be where it is now without his expertize and support





https://www.gofundme.com/mikhail-v-gubarevs-memorial

Objective of the project: To reduce fabrication cost of x-ray mirrors

X-ray Surveyor Mission Concept*



X-ray Microcalorimeter Imaging Spectrometer (XMIS) High Definition X-ray Imager (HDXI) CAT X-ray Grating Spectrometer (XGS) Readout

- 292-segmented shells nested into 42 individual mirror modules with overall size of 3 m outer diam.;
- ~ 0.2 arcsec root-mean-square (rms) slope error;
- *\$2,952M estimated total cost of the mission.*

* J. A. Gaskin, M. C. Weisskopf, A. Vikhlinin, et. al., "The X-ray Surveyor Mission: A Concept Study," Proc. SPIE 9601, UV, X-Ray, and Gamma-Ray Space Instrumentation for Astronomy XIX, 96010J (August 24, 2015); doi:10.1117/12.2190837

The X-ray Surveyor requires X-ray mirrors to achieve large throughput with high angular resolution (0.5 arcsec) in order to avoid X-ray source confusion and background contamination. High angular resolution is critical for providing unique identifications of faint X-ray sources.



X-ray Surveyor Telescope

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What can our InTILF method do for X-ray mirror fabrication?

Yashchuk, V. V., Tyurin, Y. N., and Tyurina, A. Y., "Application of time-invariant linear filter approximation to parameterization of one- and two-dimensional surface metrology with high quality x-ray optics," Proc. SPIE 8848, 88480H-1-13 (2013).

Decrease Fabrication Cost

- Faster and easier fabrication through simplified and standardized quality control
- Polishing optimization
- Enable medium size mirror manufacturers to join the X-ray mirror market

Increase Fabrication Speed

- Less metrology
- Less re-polishing

Increase Fabrication Predictability

- Metrics of quality and comparison of mirrors
- Generation of statistically equivalent metrology data
- Simulation of the X-ray mirror behavior within an X-ray optical system

see Opt Eng 54(2) 025108, Specification of x-ray mirrors in terms of system performance (Yashchuk, Samoylova, Kozhevnikov)

BeatMark software package is developed to improve the iterative polishing and metrology process



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BeatMark concept step 2: Optimization of polishing and metrology process



11/15/17

Patterns left on the mirror by polishing process are bad for imaging

Yashchuk, Samoylova, and Kozhevnikov: Specification of x-ray mirrors in terms of system performance (0pt Eng. 54-2-025108-2015)

(1)Simulated x-ray Simulated x-ray mirror imaging mirror profiles of of a single point 0.7 nm (rms the same surface 3.4 nm (P/V) 0.0 -0.4 -0.2 0.0 0.2 0.4 -0.6 -0.4 -0.2 0.0 0.2 0.4 -300 -200 -100 0 100 200 300 400 source (left) and height error rms (2) its cross sections (right) 0.7 nm (rms 3.1 nm (P/V) 400 -300 -200 -100 0 100 200 300 400 -0.4 -0.2 0.0 0.2 0.4 -0.6 -0.4 -0.2 0.0 0.2 0.4 3 (m^{-0.4}) , -0.2 **X-ray Mirror** 10.2 performance simulation 1 2 nm (rms 5.0 nm (P/V 100 200 300 40 -300 -200 -100 0 -0.4 -0.2 0.0 0.2 0.4 -0.4 -0.2 0.0 0.2 0.4 -0.6 (4) sition, Y () 0.2 10.2 1.3 nm (r 5.5 nm (P/V SECOND, -300 -200 -100 0 100 200 300 400 0.0 ∟ -0.6 Position mm -0.4 -0.2 -0.4 -0.2 0.0 0.2 0.4 0.0 0.2 It is not just rms! Horizontal position, X (µm) Horizontal position, X (µm) **STAR**

Polishing optimization idea

- Ideal mirror surface deviates from its form very slightly and in an absolutely random manner white noise random
- White noise is an absolutely random process completely devoid of pattern
- A polishing tool might leave a pattern (correlations) on a mirror. If it is detected and characterized, the mirror can be improved by optimizing polishing parameters.
- Our task is to detect and characterize the pattern

We are in search of a pattern



InTILF method looks for patterns not seen by Fourier Transform in stochastic signal





Logic of the project

- Periodic process spectral characteristics are surmised by Fourier transform
- Stochastic process spectral characteristics are surmised with statistical tools
- We think we can optimize the polishing and metrology process because we learned to characterize stochastic surface data with Invertible Time Invariant Linear Filters (InTILF)



BeatMark method provides characterization of the surface based on small metrology samples





Projects status

1) Software development

- 1D application commercial prototype is ready
- 2D application developed for finding InTILF models

2) InDevelopment

- 2D surfaces generation
- Format readers

3) Application to polishing

- OptiPro completed its first polishing experiment (planned for year II of the project)
- LBNL received the samples and is re-measuring them
- Second Star is analyzing the data
- The team is preparing the second data collect



BeatMark prototype demo

BeatMar	rk ×
File	
Profile Coeff ACF PSD Profile Edit	
Profile	nTILF Coefficients Autocovariance Function Power Spectral Density



BeatMark provide first available statistical analysis of 2D metrology profiles (surface)



BeatMark-2D assessment of two mirrors



BeatMark-2D assessment of two mirrors









BeatMark assessment of Mirror A: InTILF 5x5 matrix Residual < 1 % BeatMark assessment of Mirror B: InTILF = 3 x15 matrix Residual = 23%

How many parameters do fully describe a mirror? A: 25 B: 45



Construction of 2D InTILF model, mirror A





2D InTILF analysis of Mirror A

Mirror A data: height distribution measured with an interferometric microscope ZYGO NewViewTM-7300 equipped with 2.5× objective with ×2.0 zoom. The Microscope is available at the ALS XROL.^{18,19} The left-hand plot in Fig. 1 shows the rectangular surface area of 1.06 mm × 1.41 mm measured with the effective pixel size of 2.2 μ m (the data set consists of 640 × 480 pixels²). The measured surface topography has a characteristic 'diamond' like pattern with rms variation of the surface height of 6.75Å.



InTILF analysis of mirror B

Height distribution of the mirror B measured with the ALS XROL interferometric microscope ZYGO NewViewTM-7300 equipped with 2.5× objective with ×2.0 zoom surface area 1.06 mm × 1.41 mm effective pixel size of 2.2 μ m (640 pixels × 480 pixels) Measured surface topography has a structure of horizontal 'strips' with rms variation of the surface height of 1.74 Å.



SECOND

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22

0

-5

2D InTILF analysis of Mirror B

Original data (mirror B)

Filtered data = InTILF Model

Residual



2D InTILF analysis is stable along the mirror



for metrology data from Site 1 and Site 2. The difference is < 3.5% value



BeatMark concept step 2: Optimization of polishing and metrology process





Conclusions:

BeatMark software package:

- characterizes mirror surfaces with a small number of parameters
- needs only modest amount of metrology data to characterize the entire surface
- generates **simulated 'metrology' profiles** statistically equivalent to the original profile
- will provide the surface quality assessment through a **quality metric**
- will ultimately lead to **significant improvements in polishing**

Possible development of InTILF method may lead to comprehensive analysis of metrology data taken by instruments with different Modulation Transfer Function.



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Thank you for your attention!



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Appendix



UseCase2 – generation of 1D profiles statistically equivalent to the original using InTILF analysis

original

1000

1200

generated



UseCase2: profile simulation required high quality random number generator





Autocorrelation Q - to - spectral density P



 $X(t) = \int_{-\pi}^{\pi} e^{itu} \Omega(du) = \sum_{k=1}^{k=L} e^{itu(k)} N(0, p(u(k))|\Delta|)$ SECOND

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Stationary Random Process (SRP) and its Auto-covariance function (ACF) in 2D

Natural extension to 2D:

SPR: $x(t_1, t_2)$: $Z^2 \to R^2$ & $E(X(t_1 + h_1, t_2 + h_2) * X(t_1, t_2)) = E(x(h_1, h_2)X(0)), \forall h = (h_1, h_2) = introduce ACF Q_x(h_1) = Q_x(h_1, h_2) = E\{x(t_1 + h_1, t_2 + h_2)x(t_1, t_2)\}.$

In 2D b) means that for any natural number m, any m integers $h_{1, \dots}$, h_m and any real numbers $z_{1, \dots}$, z_m

 $\sum_{i,j=1}^m q(h_i - h_j) z_i z_j \ge 0$

ACF Q(.,.) of a stationary random process on a lattice \mathbb{Z}^2 can be represented as: $q(h_1,h_2) = \int_{-\pi}^{\pi} \int_{-\pi}^{\pi} e^{ih_1x_1 + ih_2x_2} \mu(dx_1, dx_2), (h_1,h_2) \in \mathbb{Z}^2$

